



Facility Identification Data

Name: ENDICOTT INTERCONNECT TECHNOLOGIES INC
Address: 1093 CLARK ST
ENDICOTT, NY 13760

Owner/Firm

Name: ENDICOTT INTERCONNECT TECHNOLOGIES INC
Address: 1093 CLARK ST
ENDICOTT, NY 13760, USA
Owner Classification: Corporation/Partnership

Permit Contacts

Division of Environmental Permits:
Name: MICHAEL K BARYLSKI
Address: DIVISION OF ENVIRONMENTAL PERMITS
1285 FISHER AVE
CORTLAND, NY 13045-1090
Phone:6077533095

Division of Air Resources:
Name: THOMAS A ELTER
Address: 615 ERIE BLVD WEST
SYRACUSE, NY 13204

Air Permitting Facility Owner Contact:
Name: PAUL A SPERANZA
Address: ENDICOTT INTERCONNECT TECHNOLOGIES INC
1093 CLARK ST
ENDICOTT, NY 13760
Phone:6077556179

Permit Description
Introduction

The Title V operating air permit is intended to be a document containing only enforceable terms and conditions as well as any additional information, such as the identification of emission units, emission points, emission sources and processes, that makes the terms meaningful. 40 CFR Part 70.7(a)(5) requires that each Title V permit have an accompanying "...statement that sets forth the legal and factual basis for the draft permit conditions". The purpose for this permit review report is to satisfy the above requirement by providing pertinent details regarding the permit/application data and permit conditions in a more easily understandable format. This report will also include background narrative and explanations of regulatory decisions made by the reviewer. It should be emphasized that this permit review report, while based on information contained in the permit, is a separate document and is not itself an enforceable term and condition of the permit.

Attainment Status

ENDICOTT INTERCONNECT TECHNOLOGIES INC is located in the town of UNION in the county of BROOME.

The attainment status for this location is provided below. (Areas classified as attainment are those that meet all ambient air quality standards for a designated criteria air pollutant.)

Criteria Pollutant

Attainment Status



Particulate Matter (PM)	ATTAINMENT
Particulate Matter < 10 μ in diameter (PM10)	ATTAINMENT
Sulfur Dioxide (SO ₂)	ATTAINMENT
Ozone*	TRANSPORT REGION (NON-ATTAINMENT)
Oxides of Nitrogen (NO _x)**	ATTAINMENT
Carbon Monoxide (CO)	ATTAINMENT

* Ozone is regulated in terms of the emissions of volatile organic compounds (VOC) and/or oxides of nitrogen (NO_x) which are ozone precursors.

** NO_x has a separate ambient air quality standard in addition to being an ozone precursor

Facility Description

IBM ENDICOTT IS A MANUFACTURING AND DEVELOPMENT FACILITY LOCATED 60 MILES SOUTH OF SYRACUSE, NY IN THE SUSQUEHANNA VALLEY REGION. THE FACILITY IS LOCATED AT 1701 NORTH STREET IN ENDICOTT, NY AND COVERS APPROXIMATELY 4 MILLION SQUARE FEET AND EMPLOYS NEARLY 6,500. THE SITE MISSION INCORPORATES THE FOLLOWING PROCESSES AND ACTIVITIES: 1) DEVELOP AND MANUFACTURE SEMICONDUCTOR PACKAGING PRODUCTS FOR INTERNAL AND OEM DISTRIBUTION AND SALE. THE PRIMARY IBM MANUFACTURING AND DEVELOPMENT TENANTS INCLUDING THE INTERCONNECT PRODUCTS BUSINESS UNIT WHICH SUPPORTS THE IBM MICROELECTRONICS DIVISION, OTHER IBM DIVISIONS AND OEM CUSTOMERS WITH INTERCONNECT PACKAGING PRODUCTS: 2) PROVIDE PRODUCT END-OF-LIFE MANAGEMENT (PELM) SERVICES TO ALL OF IBM AND SELECT OEM CUSTOMERS THROUGH THE GLOBAL ASSET RECOVERY SERVICES (GARS) ENDICOTT ASSET RECOVERY SERVICES (ARC); THESE SERVICES INCLUDE TRANSPORT, DISASSEMBLY AND RECYCLING OF ALL MANNER OF INFORMATION TECHNOLOGY (I/T) EQUIPMENT AS WELL AS OBSOLETE AND SURPLUS MANUFACTURING INVENTORY AND ENDICOTT SITE MANUFACTURING SCRAP. 3) MAKE EXISTING MANUFACTURING, LABORATORY AND OFFICE SPACE AVAILABLE TO IBM ORGANIZATIONS AND TO EXTERNAL CORPORATIONS FOR LEASE, SUCH AS WITH THE INTERNATIONAL FLEX TECHNOLOGY (IFT) ORGANIZATION. THIS INCLUDES WASTE DISPOSAL AND RECYCLING SERVICES AS WELL AS SOURCING CHEMICALS AND OTHER MANUFACTURING SUPPLIES, PERMITTING, REPORTING AND TRACKING AND DOCUMENTATION SERVICES. THE PRIMARY SITE RESIDENTS AND TEAMS AT IBM ENDICOTT, INCLUDING THEIR PRIMARY PRODUCTS, INCLUDE 1. IBM MICROELECTRONICS DIVISION (IMD), A) ELECTRONIC PACKAGING MANUFACTURING, B) PREPREG MANUFACTURING, C) PRINTED WIRING BOARDS (PWB) MANUFACTURING, D) CHIP CARRIERS (CERAMIC, ORGANIC, PLASTIC), E) FLEXIBLE CIRCUITS, F) DIGITAL VIDEO CHIP DESIGN, G) CIRCUIT DESIGN, H) ENGINEERING AND MANUFACTURING SERVICES, AND TOOL AND MODEL SHOP, 2. PRINTING SYSTEMS DIVISION (MIDRANGE PRINTER REPACKAGING), 3. BANKS MACHINES MANUFACTURING, 4. GLOBAL ASSET RECOVERY SERVICES (ARC), 5. IBM GLOBAL SERVICES, 6. AS/400 PROGRAMMING LABORATORY, 7. S/390 DEVELOPMENT HARDWARE AND SOFTWARE DEVELOPMENT, 8. NATIONAL ACCOUNTING SERVICES, 9. INTERNATIONAL FLEX TECHNOLOGY (IFT) - ONSITE MANUFACTURING TENANT. FOR THE PURPOSES OF THIS TITLE V APPLICATION, IBM HAS DECIDED TO CREATE ITS EMISSION UNITS BASED ON THESE PRIMARY TEAMS AND PRODUCTS. THERE ARE SIXTEEN (16) EMISSION



UNITS IDENTIFIED WITHIN THE TITLE V PERMIT APPLICATION. THESE ARE: 1)B-25900 B/259 PREPREG MANUFACTURING OPERATIONS, 2) R-CABM1 B/18 PRINTED WIRING BOARD MANUFACTURING OPERATIONS, 3) R-CABM2 B/41 PRINTED WIRING BOARD MANUFACTURING OPERATIONS , 4) R-CABM3 B/47 PRINTED WIRING BOARD MANUFACTURING OPERATIONS, 5) R-CABM4 OTHER PRINTED WIRING BOARD MANUFACTURING OPERATIONS (INCLUDING TENNANT - IFT - OPERATIONS), 7) LCC&SP LAMINATE CHIP CARRIER AND SUBSTRATE PRODUCT MFG. 8)P-BANDS B/57 PRINT BAND OPERATIONS, 9) A-SSEMB B/41 BACKPANEL ASSEMBLY OPERATIONS, 10) B-39000 SITE BOILERS AND ASSOCIATED POWERHOUSE OPERATIONS, 11) B-96000 SITE WASTE TREATMENT OPERATIONS AND ASSOCIATED OPERATION, 12)A-SSET SITE ASSET RECOVERY SERVICES OPERATIONS, 13) F-ACILI SI TEWIDE FACILITIES' SUPPORT SYSTEMS, 14) T-MSHOP TOOL AND MODEL SHOP OPERATIONS, 15) B-ANKS BACK MACHINES MANUFACTURING OPERATIONS, 16) V-IDEO DIGITAL VIDEO PRODUCTS CHIP DESIGN SUPPORT OPERATIONS.

Permit Structure and Description of Operations

The Title V permit for ENDICOTT INTERCONNECT TECHNOLOGIES INC is structured in terms of the following hierarchy: facility, emission unit, emission point, emission source and process.

A facility is defined as all emission sources located at one or more adjacent or contiguous properties owned or operated by the same person or persons under common control. The facility is subdivided into one or more emission units (EU). Emission units are defined as any part or activity of a stationary facility that emits or has the potential to emit any federal or state regulated air pollutant. An emission unit is represented as a grouping of processes (defined as any activity involving one or more emission sources (ES) that emits or has the potential to emit any federal or state regulated air pollutant). An emission source is defined as any apparatus, contrivance or machine capable of causing emissions of any air contaminant to the outdoor atmosphere, including any appurtenant exhaust system or air cleaning device. [NOTE: Indirect sources of air contamination as defined in 6 NYCRR Part 203 (i.e. parking lots) are excluded from this definition]. The applicant is required to identify the principal piece of equipment (i.e., emission source) that directly results in or controls the emission of federal or state regulated air pollutants from an activity (i.e., process). Emission sources are categorized by the following types:

- combustion - devices which burn fuel to generate heat, steam or power
 - incinerator - devices which burn waste material for disposal
 - control - emission control devices
 - process - any device or contrivance which may emit air contaminants
- that is not included in the above categories.

ENDICOTT INTERCONNECT TECHNOLOGIES INC is defined by the following emission unit(s):
Emission unit ASSEMB - THIS EMISSION UNIT CONSISTS OF MANUFACTURING OPERATIONS IN B/46 THAT SUPPORT THE BACKPANEL ASSEMBLY OPERATIONS.

Emission unit ASSEMB is associated with the following emission points (EP):
41004, 41175, 41192

It is further defined by the following process(es):

Process: CB1 is located at 2, Building 41 - Backpanel assembly operations. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: CE1 is located at 2, Building 41 - Backpanel assembly operations. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: F15 is located at 2, Building 41 - B/41 ASSEMBLY WAVE SOLDER PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE



POTENTIAL LESS THAN 10 POUNDS/HR.

Emission unit B25900 - THIS EMISSION UNIT CONSISTS OF TWO B/259 SURFACE COATING PROCESSES (TREATER TOWERS) AND ASSOCIATED CHEMICAL SUPPORT (SUPPLY, STORAGE, MIXING, GRINDING, CUTTING) FOR MANUFACTURING OF RESIN IMPREGNATED FIBERGLASS CLOTH (PREPREG) FABRICATED BY RUNNING A FIBERGLASS CLOTH WEB INTO AN EPOXY RESIN/SOLVENT MIXTURE AND THROUGH OVENS TO CURE THE RESIN. THESE PROCESSES ARE CONSIDERED SURFACE COATING OPERATIONS UNDER 6NYCRR PART 228. ADDITIONALLY, TWO THERMAL OXIDATION SYSTEMS ARE PRESENT AS AIR CLEANING DEVICES FOR EACH TREATER TOWER.

Emission unit B25900 is associated with the following emission points (EP):
25901, 25902, 25903, 25905, 25907, 25915

It is further defined by the following process(es):

Process: 004 is located at 1, Building 259 - B/259 MANUFACTURING RELATED FUME HOODS AND FLOW PRESS. THE EMISSION SOURCES IN THIS EMISSION UNIT ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: 006 is located at 1, Building 259 - B/259 TREATER TOWER SLITTER/SHEETER OPERATIONS; PUNCHES AND OVENS WITH ASSOCIATED DUST COLLECTORS. THE EMISSION SOURCES IN THIS EMISSION UNIT ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: 008 is located at 1, Building 259 - B/259 MANUFACTURING RELATED FUME HOODS AND GLOVE BOX. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: 1NC is located at 1, Building 259 - B/259 TREATER TOWER #1 (PREPREG MANUFACTURING PROCESS SUBJECT TO 6NYCRR PART 228 SURFACE COATING OPERATION) WITH ASSOCIATED THERMAL OXIDIZER #1. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS SUBJECT TO VOC RACT.

Process: 2NC is located at 1, Building 259 - B/259 TREATER TOWER #2 (PREPREG MANUFACTURING PROCESS SUBJECT TO 6NYCRR PART 228 SURFACE COATING OPERATION) WITH ASSOCIATED THERMAL OXIDIZER #2. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS SUBJECT TO VOC RACT.

Process: 2TO is located at Building 259 - B/259 TREATER TOWER #2 PRE-PREG MANUFACTURING PROCESS UTILIZING A HAZARDOUS AIR POLLUTANT AS THE SOLVENT, SUBJECT TO 40 CFR 63 SUBPART OOOO, FABRIC COATING.

Emission unit B96000 - THIS EMISSION UNIT CONSISTS OF IBM'S B/96 WASTE TREATMENT FACILITY, INCLUDING ALL OF ITS CHEMICAL TREATMENT SYSTEMS AND SUPPORT EQUIPMENT FOR BOTH SITE MANUFACTURING WASTE WATER SYSTEMS, AS WELL AS REMEDIATED GROUNDWATER.

Emission unit B96000 is associated with the following emission points (EP):
96005, 96024, 96029

It is further defined by the following process(es):

Process: CAU is located at 1, Building 96 - B/96 WASTE TREATMENT OPERATIONS - PACKED TOWER / AIR STRIPPER FOR GROUNDWATER REMEDIATION AND PLANT SOLVENT WATER TREATMENT, INCLUDING ASSOCIATED AIR ABATEMNT SYSTEM (CAU). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR AND B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR. THIS EMISSION SOURCE IS SUBJECT TO 6 NYCRR 212 VOC RACT.

Process: F24 is located at 1, Building 96 - B/96 WASTE TREATMENT PLANT OPERATIONS, INCLUDING BIO, CHROME, PERSULFATE, AND GENERAL RINSE TREATMENT (INCLUDING ASSOCIATED ABATEMENT SYSTEM (SCRUBBER)). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND



SOLID PARTICULATES (SUBJECT TO PART 212).

Process: LST is located at 1, Building 96 - B/96 WASTE TREATMENT PLANT LIME SLURRY TANK FOR PH ADJUSTMENT. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Emission unit PWB001 - PWB001 consists of process equipment located in Buildings 2, 10, 18, 21, 41, 47 and 53 that supports the manufacture of printed wiring boards (PWBs). These operations include surface preparation, lamination of copper foil, circuitization (including photoresist apply, resist expose, resist develop, metal etching and resist stripping), drilling, hole desmear, hole plating, protective coating sequence (soldermask apply, expose, develop and cure), finish operations, inspection, test, profile and stock.

Emission unit PWB001 is associated with the following emission points (EP):

02008, 02010, 02016, 02021, 02024, 10025, 10V02, 18444, 18659, 18674, 18680, 18681, 18682, 18683, 18685, 18695, 18V04, 18V05, 18V06, 18V07, 18V08, 21006, 21029, 21067, 21076, 21079, 21086, 41157, 41171, 41195, 41V11, 47174, 47177, 47187, 47188, 47189, 47194, 47197, 47200, 47204, 47205, 47217, 47228, 47230, 47231, 47234, 47242, 47246, 47247, 53001, 53002, 53003, 53005, 53010, 53011, 53012, 53013

It is further defined by the following process(es):

Process: AI1 is located at 3, Building 18 - B/18 DEVELOP, ETCH AND STRIP (DES) OPERATIONS INCLUDING FOUR MANUFACTURING LINES (D320 DES LINE, NORTH DES, SOUTH DES AND FINELINE DES) -EXHAUSTS ONLY DEVELOP AND STRIP SECTIONS OF EACH PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AJ1 is located at 3, Building 18 - B/18 COPPER FOIL LAMINATION PROCESSES AND ASSOCIATED PRECLEAN PROCESSES. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AK1 is located at 3, Building 18 - B/18 ACID COPPER DES LINE (ACL) DEVELOP AND STRIP SECTIONS ONLY. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AN1 is located at 3, Building 18 - B/18 DES LINES (ETCHING SECTIONS ONLY), PLATERS AND ASSOCIATED AIR ABATEMENT (SCRUBBER) INCLUDES FIVE DES LINE ETCHERS (D320 DES, NORTH DES, SOUTH DES, FINELINE DES AND ACL DES), CHEM POLISH, FLUID HEAD ETCHER, THIN PANEL PLATER, AND DEBURR/DESMEAR PROCESSES. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR, B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: AO1 is located at 2, Building 47 - B/47 BAKER WET LINE #4 LAMINATIONS PROCESS WHERE METAL COLLOID IS DEPOSITED ON SURFACE OF PANEL MATERIAL. B/47 SOLVENT PLATE CLEAN HOOD TO REMOVE EPOXY LAMINATIONS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AQ1 is located at 2, Building 47 - B/47 Baker Wet Line #4 lamination process where metal colloid is deposited on surface of paint material. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AR1 is located at 2, Building 47 - B/47 BAKER WET LINE #5 LAMINATIONS PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AS1 is located at 2, Building 47 - B/47 TIN-LEAD PLATING LINE. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AT1 is located at 2, Building 47 - B/47 BENZYL ALCOHOL STRIPPER, PROPYLENE CARBONATE DEVELOPER AND ASSOCIATED OVENS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AV1 is located at Building 47 - B/47 CUPRIC CHLORIDE ETCHER. THE EMISSION SOURCES



ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AW1 is located at 2, Building 47 - B/47 HOLE PUNCHES / PRESSES AND ASSOCIATED DUST COLLECTOR. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: AX1 is located at 2, Building 47 - B/47 CHORITE/ BOND FILM LINES #1 AND #2 (LAMINATIONS & SURFACE PREP PROCESSES) - INCLUDING AIR ABATEMENT SYSTEM (SCRUBBER).

Process: AZ1 is located at 2, Building 47 - B/47 ELECTROLESS GOLD PLATING LINE WITH ASSOCIATED AIR ABATEMENT SYSTEM (SCRUBBER). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR, B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: BA1 is located at 2, Building 47 - B/47 ADDITIVE PLATING SUPPORT EQUIPMENT AND ASSOCIATED PROCESS HOODS AND DRYERS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR AND B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BE1 is located at 2, Building 47 - B/47 AMMONIA CAL ETCH LINE SUPPORT TANKS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BF1 is located at 2, Building 47 - B/47 SOLDERMASK COATING OPERATIONS AND LAMINATORS (INCLUDING SUPPORT OVENS AND HOODS). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BG1 is located at 2, Building 47 - B/47 AMMONIA ETCH LINE, AQUEOUS DEVELOPER; AND PRECLEAN. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BH1 is located at 2, Building 47 - B/47 PLASMA ETCHERS #1 AND #2. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BI1 is located at 2, Building 47 - B/47 HOLE DRILL OPERATIONS AND ASSOCIATED DUST COLLECTOR. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: BJ1 is located at 2, Building 47 - B/47 PROPYLENE CARBONATE DEVELOPER AND STRIPPER. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BP2 is located at 1, Building 18 - B/18 CHIP CARRIER BURR REMOVAL PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BQ1 is located at Building 18 - B/18 PERSULFATE ETCHER AND DEBURR/DESMEAR OPERATIONS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: BR1 is located at 2, Building 47 - PROCESS NAME: EMISSION POINT 18686 - EMISSION POINT 18686 EXHAUSTS A VARIETY OF EXEMPT, TRIVIAL, AND INSIGNIFICANT EMISSION SOURCES. THIS PROCESS APPLIES TO THE INSIGNIFICANT EMISSION SOURCES. ADDITIONAL INFORMATION ABOUT THIS PROCESS IS NOT REQUIRED IN THIS APPLICATION. THE SUPPORTING DOCUMENTATION PROVIDES MORE DETAILS ON THE BASIS FOR THE EMISSION ESTIMATE.

Process: BY1 is located at 3, Building 41 - B/41 OXIDE REMOVE PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT , B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: CA1 is located at 3, Building 41 - B/41 SOLDER REFLOW OVENS AND HOOD.



Process: CH1 is located at 2, Building 41 - B/41 GOLD LINE (LAMINATIONS, PLATING, DEVELOP, STRIP) OPERATIONS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR AND B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: CN1 is located at Building 53 - B/53 SOLDERMASK CURE OPERATIONS INCLUDING ASSOCIATED OVENS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR AND B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR (SUBJECT TO PART 212).

Process: CO1 is located at Building 53 - B/53 SOLDERMASK APPLY/SCREEN OPERATIONS INCLUDING AUTOSCREEN COATER #1, DIAZO DEVELOPER, SOLDERMASK CURE/DRY OPERATIONS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR AND B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR (SUBJECT TO PART 212).

Process: CP1 is located at Building 53 - B/53 ENTEK SURFACE OXIDATION REMOVAL LINES # 1 AND #2 WITH ASSOCIATED SUPPORT SYSTEMS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: CQ1B/53 PANEL DRILL OPERATIONS WITH ASSOCIATED DUST COLLECTOR. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: CR1 is located at Building 53 - B/53 PROTECTIVE COATING APPLICATION PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: CS1 is located at Building 53 - B/53 CHROME MASK FABRICATION PROCESS AND PROTECTIVE COAT DEVELOPMENT LINE (WITH ASSOCIATED SINKS AND HOODS). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: CT1 is located at Building 53 - B/53 SOLDERMASK APPLY/SCREEN OPERATIONS INCLUDING FOUR SCREEN PRINTERS, SUPPORT HOODS, OVENS AND DEVELOPER. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: CU1 is located at Building 53 - B/53 DYNAMOTION DRILL MACHINE. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: CW1 is located at Building 21 - B/21 ROBOTIC SILICONE ENCAPSULANT APPLY AND BAKE PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: DC2 is located at Building 18 - B/18 drilling operations and associated dust collection systems. The emission sources associated with this process emit B-rated pollutants at an emission rate less than 10 pounds per hour and solid particulate (subject to Part 212).

Process: DC6B/41 Static Eliminator and associated dust collector system. The emission sources associated with this process emit B-rated pollutants at an emission rate potential less than 10 pounds per hour and solid particulate (subject to Part 212).

Process: DS1 is located at Building 10 - b/10 SPINDLE VACUUM. THE EMISSION SOURCE ASSOCIATED WITH THIS PROCESS EMITS B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS PER HOUR AND SOLID PARTICULATE (SUBJECT TO PART 212).

Process: GK1 is located at 2, Building 21 - B/21 FLUX APPLY PROCESS/ SOLDER REFLOW OVEN OPERATIONS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: GL1 is located at 2, Building 21 - B/21 SOLDER REFLOW APPLY OPERATIONS AND OVENS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: GM1 is located at 2, Building 21 - B/21 HOLE DRILL OPERATIONS WITH ASSOCIATED DUST



COLLECTORS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: GN1 is located at 2, Building 21 - B/21 PROCESS SUPPORT OVENS.

Process: GO1 is located at Building 21 - B/21 EXTRUSION SCREEN PRINTING OPERATIONS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS PER HOUR.

Process: GQ1 is located at Building 10 - B/10 PROFILE LP SCORE TOOL OPERATIONS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS PER HOUR AND SOLID PARTICULATE (SUBJECT TO PART 212).

Process: HP1 is located at 3, Building 18 - B/18 HORIZONTAL DESMEAR AND ELECTROLESS COPPER PLATER WITH ASSOCIATED AIR ABATEMENT SYSTEM (SCRUBBER). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR AND B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: JD1 is located at 2, Building 47 - B/18 Somar Resist Laminator. This process emits B rated pollutants at an emission rate potential less than 10 pounds per hour.

Process: KG1B/18 WASTE TREATMENT (GENERAL RINSE SYSTEM) TRANSFER TANKS FOR MANUFACTURING INORGANIC PROCESS WASTES. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: LX1 is located at 2, Building 47 - B/47 SEED WETLINE SUPPORT SYSTEMS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: PQ1 is located at 2, Building 2 - B/02 SOLDER REFLOW OVENS, STENCIL CLEAN OPERATIONS AND PROCESS SUPPORT OVENS.

Process: QQ1 is located at 2, Building 2 - B/02 SOLDER PASTE APPLY AND SOLDER REFLOW AND ADHESIVE CURE OVENS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: RQ1 is located at 2, Building 2 - B/02 WAVE SOLDER PROCESS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: SD1 is located at 3, Building 18 - B/18 DEBURR MACHINE AND WASTE TANK. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: SQ1 is located at 2, Building 2 - B/02 RESIST COATER (APPLY) AND DRYER.

Process: TQ1 is located at 2, Building 2 - B/02 SOLDER SPRAY FLUXER. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: VP1 is located at 3, Building 18 - B/18 VERTICAL ACID COPPER PLATER AND ASSOCIATED AIR ABATEMENT SYSTEM (SCRUBBER). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR, B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: XE1 is located at 2, Building 47 - B/47 PUMICE MIX OPERATIONS AND TANK AND ASSOCIATED DUST COLLECTOR. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Emission unit RCABM5 - THIS EMISSION CONSISTS OF PROCESS EQUIPMENT LOCATED IN B/258 THAT SUPPORTS THE MANUFACTURE OF PRINTED CIRCUIT BOARDS (BLUE DEVIL PRODUCT). THESE OPERATIONS INCLUDE SURFACE PREPARATION, LAMINATION OF COPPER FOIL/LAYERS, CIRCUITIZATION, DRILLING, HOLE DESMEAR, HOLE PLATING, PROTECTIVE COATING, AND FINISH OPERATIONS (GOLD, INSPECTION, TEST, PROFILE AND STOCK).

Emission unit RCABM5 is associated with the following emission points (EP):

25801, 25802, 25805, 25807, 25808, 25810



It is further defined by the following process(es):

Process: AA1 is located at Building 258 - B/258 CUPRIC ETCH SUPPORT, LAMINATORS, LAMINATIONS PRESSES, FUME HOODS AND OVENS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: AA3 is located at Building 258 - B/258 ELECTRO DEPOSITED (ED) RESIST COATER OVENS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AA4 is located at Building 258 - B/258 PHOTSENSITOMETRY OVENS AND FUME HOOD. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AB1 is located at Building 258 - B/258 BLUE DEVIL CIRCUIT BOARD MANUFACTURING PROCESSES, INCLUDING ACID COPPER ELECTROPLATE, PRECLEAN, CUPRIC ETCH, ED RESIST DEVELOP, CHROME LINE, PHOTOLAB STRIPPER, PHOTOLAB DEVELOPER, SEEDER/FINELINE PROCESS AND WET LINE #1 COPPER ETCHERS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR AND B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Process: AE1 is located at Building 258 - B/258 MANUFACTURING OPERATIONS INCLUDING CHROME ETCH OPERATIONS, PLASMA REACTOR, CUPRIC CHLORIDE ETCHER WITH ASSOCIATED ABATEMENT SYSTEM (SCRUBBER). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR, B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: AE3 is located at Building 258 - Building 258 manufacturing operations. Non-scrubbed portions of process AE1, including cupric chloride etcher and interposer plating baths. The emission sources associated with this process emit B-rated pollutants at an emission rate potential less than 10 pounds/hr.

Process: AG1 is located at Building 258 - B/258 CIRCUIT PANEL LAY-UP TABLES AND PUNCH; WITH ASSOCIATED DUST COLLECTOR. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT SOLID PARTICULATES (SUBJECT TO PART 212).

Process: MZ1 is located at Building 258 - B/258 ELECTRODEPOSITED (ED) RESIST COATER AND SUPPORT SYSTEMS, INCLUDING ASSOCIATED AIR ABATEMENT SYSTEM (SCRUBBER). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Process: PH1 is located at Building 258 - B/258 PLATED THROUGH HOLE (PTH) COPPER PLATER WITH ASSOCIATED AIR ABATEMENT SYSTEM (SCRUBBER). THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS EMIT A-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 1.0 POUND/HR, B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR AND SOLID PARTICULATES (SUBJECT TO PART 212).

Emission unit TMSHOP - THIS EMISSION UNIT CONSISTS OF PROCESSES THAT ARE UTILIZED BY THE SITE'S TOOL AND MODEL SHOP/PRECISION ENGINEERING GROUP. THESE PROCESSES ARE USED FOR CRAFTING PRECISION METAL OR PLASTIC PRODUCTION PARTS, MODELS OR SPECIALTY ITEMS. THE PROCESSES INCLUDE INJECTION PRESSES, SOLDER STATIONS, BUFFERS, SANDERS, DRILLS, LATHES AND NUMEROUS OTHER TOOLING PROCESSES.

Emission unit TMSHOP is associated with the following emission points (EP):

41144

It is further defined by the following process(es):

Process: DC1 is located at 1, Building 46 - PROCESS NAME: EMISSION POINT 46111 - EMISSION POINT 46111 EXHAUSTS A VARIETY OF EXEMPT, TRIVIAL, AND INSIGNIFICANT EMISSION SOURCES. THIS PROCESS APPLIES TO THE INSIGNIFICANT EMISSION SOURCES. ADDITIONAL INFORMATION ABOUT THIS PROCESS IS NOT REQUIRED IN THIS APPLICATION. THE SUPPORTING DOCUMENTATION PROVIDES MORE DETAILS ON THE BASIS FOR THE EMISSION ESTIMATE.



Process: TM1 is located at 3, Building 41 - B/41 TOOL AND MODEL SHOP INJECTION MOLDING PROCESSES, OVENS AND HOODS. THE EMISSION SOURCES ASSOCIATED WITH THIS PROCESS B-RATED POLLUTANTS AT AN EMISSION RATE POTENTIAL LESS THAN 10 POUNDS/HR.

Title V/Major Source Status

ENDICOTT INTERCONNECT TECHNOLOGIES INC is subject to Title V requirements. This determination is based on the following information:

The facility is a major source of NOx, SO2, VOC and HAP.

Compliance Status

Facility is in compliance with all requirements

SIC Codes

SIC or Standard Industrial Classification code is an industrial code developed by the federal Office of Management and Budget for use, among other things, in the classification of establishments by the type of activity in which they are engaged. Each operating establishment is assigned an industry code on the basis of its primary activity, which is determined by its principal product or group of products produced or distributed, or services rendered. Larger facilities typically have more than one SIC code.

SIC Code

Description

3579	OFFICE MACHINES, NEC
3672	PRINTED CIRCUIT BOARDS

SCC Codes

SCC or Source Classification Code is a code developed and used" by the USEPA to categorize processes which result in air emissions for the purpose of assessing emission factor information. Each SCC represents a unique process or function within a source category logically associated with a point of air pollution emissions. Any operation that causes air pollution can be represented by one or more SCC's.

SCC Code

Description

3-13-065-00	ELECTRICAL EQUIPMENT ELECTRICAL EQUIPMENT - SEMICONDUCTOR MANUFACTURING INTEGRATED CIRCUIT MANUFACTURING - GENERAL
3-13-065-99	ELECTRICAL EQUIPMENT ELECTRICAL EQUIPMENT - SEMICONDUCTOR MANUFACTURING SEMICONDUCTOR MFG-MISCELLANEOUS OPERATIONS-GENERAL-SPECIFY MATERIAL
4-02-030-01	SURFACE COATING OPERATIONS SURFACE COATING OPERATIONS - SEMICONDUCTORS ORGANIC SOLVENT-SURFACE COATING-SEMICONDUCTORS-SPECIFY SOLVENT

Facility Emissions Summary

In the following table, the CAS No. or Chemical Abstract Series code is an identifier assigned to every chemical compound. [NOTE: Certain CAS No.'s contain a 'NY' designation within them. These are not true CAS No.'s but rather an identification which has been developed by the department to identify groups of contaminants which ordinary CAS No.'s do not do. As an example, volatile organic compounds or VOC's are identified collectively by the NY CAS No. 0NY998-00-0.] The PTE refers to the Potential to Emit. This is defined as the maximum capacity



Permit Review Report

Permit ID: 7-0346-00032/00209

Renewal Number: 1

10/22/2008

of a facility or air contaminant source to emit any air contaminant under its physical and operational design. Any physical or operational limitation on the capacity of the facility or air contamination source to emit any air contaminant, including air pollution control equipment and/or restrictions on the hours of operation, or on the type or amount of material combusted, stored, or processed, shall be treated as part of the design only if the limitation is contained in federally enforceable permit conditions. The PTE Range represents an emission range for a contaminant. Any PTE quantity that is displayed represents a facility-wide emission cap or limitation for that contaminant. If no PTE quantity is displayed, the PTE Range is provided to indicate the approximate magnitude of facility-wide emissions for the specified contaminant in terms of tons per year (tpy). The term 'HAP' refers to any of the hazardous air pollutants listed in section 112(b) of the Clean Air Act Amendments of 1990. Total emissions of all hazardous air pollutants are listed under the special NY CAS No. 0NY100-00-0. In addition, each individual hazardous air pollutant is also listed under its own specific CAS No. and is identified in the list below by the (HAP) designation.

Cas No.	Contaminant Name	PTE		Range	
		lbs/yr			
000084-74-2	1,2-BENZENEDICARBOXYLIC ACID, DIBUTYL ESTER			pteyear	Y
000107-21-1	1,2-ETHANEDIOL	pteyear		Y	
000123-31-9	1,4-BENZENEDIOL	pteyear		Y	
000123-91-1	1,4-DIETHYLENE DIOXIDE	pteyear		Y	
000108-10-1	2-PENTANONE, 4-METHYL	pteyear		Y	
000075-05-8	ACETONITRILE	pteyear		Y	
007440-38-2	ARSENIC	pteyear		Y	
014263-59-3	AURATE(1-), TETRAKIS(CYANO-C)-, POTASSIUM			pteyear	Y
000075-15-0	CARBON DISULFIDE	pteyear		Y	
000630-08-0	CARBON MONOXIDE	pteyear		B	
007782-50-5	CHLORINE	pteyear		Y	
007738-94-5	CHROMIC ACID	pteyear		Y	
007440-47-3	CHROMIUM	pteyear		Y	
000075-09-2	DICHLOROMETHANE	pteyear		Y	
000131-11-3	DIMETHYL PHTHALATE	pteyear		Y	
000071-55-6	ETHANE, 1,1,1-TRICHLORO	pteyear		Y	
000075-34-3	ETHANE, 1,1-DICHLORO-	pteyear		Y	
000111-42-2	ETHANOL, 2,2'-IMINOBIS-	pteyear		Y	
000100-41-4	ETHYLBENZENE	pteyear		Y	
000050-00-0	FORMALDEHYDE	pteyear		Y	
0NY100-00-0	HAP	pteyear		F	
000074-90-8	HYDROCYANIC ACID	pteyear		Y	
007647-01-0	HYDROGEN CHLORIDE	pteyear		Z	
007664-39-3	HYDROGEN FLUORIDE	pteyear		Y	
007439-92-1	LEAD	pteyear		Y	
007439-96-5	MANGANESE	pteyear		Y	
007439-97-6	MERCURY	pteyear		Y	
000080-62-6	METHYL ACRYLIC ACIDMETHYL ESTER		pteyear		Y
000067-56-1	METHYL ALCOHOL	pteyear		Y	
000078-93-3	METHYL ETHYL KETONE	pteyear		Z	
007440-02-0	NICKEL METAL AND INSOLUBLE COMPOUNDS			pteyear	Y
000098-95-3	NITROBENZENE	pteyear		Y	
0NY210-00-0	OXIDES OF NITROGEN	pteyear		H	
0NY075-00-0	PARTICULATES	pteyear		B	
000127-18-4	PERCHLOROETHYLENE	pteyear		Y	
000108-95-2	PHENOL	pteyear		Y	
0NY075-00-5	PM-10	pteyear		B	
000143-33-9	SODIUM CYANIDE	pteyear		Y	
013770-89-3	SULFAMIC ACID, NICKEL(2+) SALT (2:1)		pteyear		Y
007446-09-5	SULFUR DIOXIDE	pteyear		A	
007786-81-4	SULFURIC ACID, NICKEL(2+) SALT (1:1)		pteyear		Y
000108-88-3	TOLUENE	pteyear		Y	
000079-01-6	TRICHLOROETHYLENE	pteyear		Y	
000075-01-4	VINYL CHLORIDE	pteyear		Y	
0NY998-00-0	VOC	pteyear		H	
001330-20-7	XYLENE, M, O & P MIXT.	pteyear		Y	



NOTIFICATION OF GENERAL PERMITTEE OBLIGATIONS

Item A: Emergency Defense - 6NYCRR Part 201-1.5

An emergency constitutes an affirmative defense to an action brought for noncompliance with emissions limitations or permit conditions for all facilities in New York State.

(a) The affirmative defense of emergency shall be demonstrated through properly signed, contemporaneous operating logs, or other relevant evidence that:

- (1) An emergency occurred and that the facility owner and/or operator can identify the cause(s) of the emergency;
- (2) The equipment at the permitted facility causing the



emergency was at the time being properly operated;

(3) During the period of the emergency the facility owner and/or operator took all reasonable steps to minimize levels of emissions that exceeded the emission standards, or other requirements in the permit; and

(4) The facility owner and/or operator notified the Department within two working days after the event occurred. This notice must contain a description of the emergency, any steps taken to mitigate emissions, and corrective actions taken.

(b) In any enforcement proceeding, the facility owner and/or operator seeking to establish the occurrence of an emergency has the burden of proof.

(c) This provision is in addition to any emergency or upset provision contained in any applicable requirement.

Item B: Public Access to Recordkeeping for Title V Facilities - 6NYCRR Part 201-1.10(b)

The Department will make available to the public any permit application, compliance plan, permit, and monitoring and compliance certification report pursuant to Section 503(e) of the Act, except for information entitled to confidential treatment pursuant to 6NYCRR Part 616 - Public Access to records and Section 114(c) of the Act.

Item C: Timely Application for the Renewal of Title V Permits - 6 NYCRR Part 201-6.3(a)(4)

Owners and/or operators of facilities having an issued Title V permit shall submit a complete application at least 180 days, but not more than eighteen months, prior to the date of permit expiration for permit renewal purposes.

Item D: Certification by a Responsible Official - 6 NYCRR Part 201-6.3(d)(12)

Any application, form, report or compliance certification required to be submitted pursuant to the federally enforceable portions of this permit shall contain a certification of truth, accuracy and completeness by a responsible official. This certification shall state that based on information and belief formed after reasonable inquiry, the statements and information in the document are true, accurate, and complete.

Item E: Requirement to Comply With All Conditions - 6 NYCRR Part 201-6.5(a)(2)

The permittee must comply with all conditions of the Title V facility permit. Any permit non-compliance constitutes a violation of the Act and is grounds for enforcement action; for permit termination, revocation and reissuance, or modification; or for denial of a permit renewal application.

Item F: Permit Revocation, Modification, Reopening, Reissuance or Termination, and Associated Information Submission Requirements - 6 NYCRR Part 201-6.5(a)(3)



This permit may be modified, revoked, reopened and reissued, or terminated for cause. The filing of a request by the permittee for a permit modification, revocation and reissuance, or termination, or of a notification of planned changes or anticipated noncompliance does not stay any permit condition.

Item G: Cessation or Reduction of Permitted Activity Not a Defense - 6NYCRR Part 201-6.5(a)(5)

It shall not be a defense for a permittee in an enforcement action to claim that a cessation or reduction in the permitted activity would have been necessary in order to maintain compliance with the conditions of this permit.

Item H: Property Rights - 6 NYCRR Part 201-6.5(a)(6)

This permit does not convey any property rights of any sort or any exclusive privilege.

Item I: Severability - 6 NYCRR Part 201-6.5(a)(9)

If any provisions, parts or conditions of this permit are found to be invalid or are the subject of a challenge, the remainder of this permit shall continue to be valid.

Item J: Permit Shield - 6 NYCRR Part 201-6.5(g)

All permittees granted a Title V facility permit shall be covered under the protection of a permit shield, except as provided under 6 NYCRR Subpart 201-6. Compliance with the conditions of the permit shall be deemed compliance with any applicable requirements as of the date of permit issuance, provided that such applicable requirements are included and are specifically identified in the permit, or the Department, in acting on the permit application or revision, determines in writing that other requirements specifically identified are not applicable to the major stationary source, and the permit includes the determination or a concise summary thereof. Nothing herein shall preclude the Department from revising or revoking the permit pursuant to 6 NYCRR Part 621 or from exercising its summary abatement authority. Nothing in this permit shall alter or affect the following:

- i. The ability of the Department to seek to bring suit on behalf of the State of New York, or the Administrator to seek to bring suit on behalf of the United States, to immediately restrain any person causing or contributing to pollution presenting an imminent and substantial endangerment to public health, welfare or the environment to stop the emission of air pollutants causing or contributing to such pollution;
- ii. The liability of a permittee of the Title V facility for any violation of applicable requirements prior to or at the time of permit issuance;



- iii. The applicable requirements of Title IV of the Act;
- iv. The ability of the Department or the Administrator to obtain information from the permittee concerning the ability to enter, inspect and monitor the facility.

Item K: Reopening for Cause - 6 NYCRR Part 201-6.5(i)

This Title V permit shall be reopened and revised under any of the following circumstances:

- i. If additional applicable requirements under the Act become applicable where this permit's remaining term is three or more years, a reopening shall be completed not later than 18 months after promulgation of the applicable requirement. No such reopening is required if the effective date of the requirement is later than the date on which this permit is due to expire, unless the original permit or any of its terms and conditions has been extended by the Department pursuant to the provisions of Part 201-6.7 and Part 621.
- ii. The Department or the Administrator determines that the permit contains a material mistake or that inaccurate statements were made in establishing the emissions standards or other terms or conditions of the permit.
- iii. The Department or the Administrator determines that the Title V permit must be revised or reopened to assure compliance with applicable requirements.
- iv. If the permitted facility is an "affected source" subject to the requirements of Title IV of the Act, and additional requirements (including excess emissions requirements) become applicable. Upon approval by the Administrator, excess emissions offset plans shall be deemed to be incorporated into the permit.

Proceedings to reopen and issue Title V facility permits shall follow the same procedures as apply to initial permit issuance but shall affect only those parts of the permit for which cause to reopen exists.

Reopenings shall not be initiated before a notice of such intent is provided to the facility by the Department at least thirty days in advance of the date that the permit is to be reopened, except that the Department may provide a shorter time period in the case of an emergency.

Item L: Permit Exclusion - ECL 19-0305

The issuance of this permit by the Department and the receipt thereof by the Applicant does not and shall not be construed as barring, diminishing, adjudicating or in any way affecting any legal, administrative or equitable rights or claims, actions, suits, causes of action or demands whatsoever that the Department may have against the Applicant for violations based on facts and circumstances alleged



to have occurred or existed prior to the effective date of this permit, including, but not limited to, any enforcement action authorized pursuant to the provisions of applicable federal law, the Environmental Conservation Law of the State of New York (ECL) and Chapter III of the Official Compilation of the Codes, Rules and Regulations of the State of New York (NYCRR). The issuance of this permit also shall not in any way affect pending or future enforcement actions under the Clean Air Act brought by the United States or any person.

Item M: Federally Enforceable Requirements - 40 CFR 70.6(b)

All terms and conditions in this permit required by the Act or any applicable requirement, including any provisions designed to limit a facility's potential to emit, are enforceable by the Administrator and citizens under the Act. The Department has, in this permit, specifically designated any terms and conditions that are not required under the Act or under any of its applicable requirements as being enforceable under only state regulations.

NOTIFICATION OF GENERAL PERMITTEE OBLIGATIONS

Item A: General Provisions for State Enforceable Permit Terms and Condition - 6 NYCRR Part 201-5

Any person who owns and/or operates stationary sources shall operate and maintain all emission units and any required emission control devices in compliance with all applicable Parts of this Chapter and existing laws, and shall operate the facility in accordance with all criteria, emission limits, terms, conditions, and standards in this permit. Failure of such person to properly operate and maintain the effectiveness of such emission units and emission control devices may be sufficient reason for the Department to revoke or deny a permit.

The owner or operator of the permitted facility must maintain all required records on-site for a period of five years and make them available to representatives of the Department upon request. Department representatives must be granted access to any facility regulated by this Subpart, during normal operating hours, for the purpose of determining compliance with this and any other state and federal air pollution control requirements, regulations or law.

Regulatory Analysis

Location Facility/EU/EP/Process/ES	Regulation	Condition	Short Description
FACILITY			
	Powers and Duties of the		Department with respect to air pollution control
B-25900/-/2TO	40CFR 63-0000.4290		
	Fabric Coating, Printing,		& Dyeing NESHP -



B-25900/-/2TO	40CFR 63-0000.4292 (b)	Emission limits
Fabric		
		Coating/Printing/Dyeing NESHAP - Operating Limits
B-25900/-/2TO	40CFR 63-0000.4293 (b)	
Fabric		
		Coating/Printing/Dyeing NESHAP - Work Practice Standards
B-25900/-/2TO	40CFR 63-0000.4311 (a)	
Fabric		
		Coating/Printing/Dyeing NESHAP - Reporting
B-25900/-/2TO	40CFR 63-0000.4311 (c)	
Fabric		
		Coating/Printing/Dyeing NESHAP - Reporting
B-25900/-/2TO	40CFR 63-0000.4351	
Fabric		
		Coating/Printing/Dyeing NESHAP - Overall Control Efficiency and Oxidizer Outlet Concentration
B-25900/-/2TO	40CFR 63-0000.4352	
Fabric		
		Coating/Printing/Dyeing NESHAP - Overall Control Efficiency and Oxidizer Outlet Concentration Option- Cont. Compliance
B-25900/-/2TO	40CFR 63-0000.4360	
Fabric		
		Coating/Printing/Dyeing NESHAP - General Requirements for Performance Testing
B-25900/-/2TO	40CFR 63-0000.4361	
Emission Capture System		
		Efficiency
B-25900/-/2TO	40CFR 63-0000.4364	
Requirements for CPMS		
		installation, operation and maintenance
FACILITY	40CFR 68	
Chemical accident		
		prevention provisions
FACILITY	40CFR 82-F	
Protection of		
		Stratospheric Ozone - recycling and emissions reduction
FACILITY	6NYCRR 200.6	
Acceptable ambient air		
		quality.
FACILITY	6NYCRR 200.7	
FACILITY	6NYCRR 201-1.4	



	Unavoidable noncompliance	
FACILITY	6NYCRR 201-1.7	and violations
FACILITY	6NYCRR 201-1.8	
	Prohibition of	
FACILITY	6NYCRR 201-3.2 (a)	reintroduction of collected contaminants to the air
	Exempt Activities - Proof	
FACILITY	6NYCRR 201-3.3 (a)	of eligibility
	Trivial Activities -	
FACILITY	6NYCRR 201-6	proof of eligibility
	Title V Permits and the	
FACILITY	6NYCRR 201-6.5 (a) (4)	Associated Permit Conditions
FACILITY	6NYCRR 201-6.5 (a) (7)	
FACILITY	6NYCRR 201-6.5 (a) (8)	
B-25900/-/1NC	6NYCRR 201-6.5 (b) (1)	
B-25900/-/2NC	6NYCRR 201-6.5 (b) (1)	
FACILITY	6NYCRR 201-6.5 (c)	
	Permit conditions for	
FACILITY	6NYCRR 201-6.5 (c) (2)	Recordkeeping and Reporting of Compliance Monitoring
	Permit conditions for	
FACILITY	6NYCRR 201-6.5 (c) (3) (ii)	Recordkeeping and Reporting of Compliance Monitoring
	Permit conditions for	
FACILITY	6NYCRR 201-6.5 (d) (5)	Recordkeeping and Reporting of Compliance Monitoring
FACILITY	6NYCRR 201-6.5 (e)	
FACILITY	6NYCRR 201-6.5 (f)	
FACILITY	6NYCRR 201-6.5 (f) (6)	
FACILITY	6NYCRR 202-1.1	
FACILITY	6NYCRR 202-2.1	



Emission Statements -		Applicability
FACILITY	6NYCRR 202-2.5	
Emission Statements -		record keeping requirements.
FACILITY	6NYCRR 211.2	
General Prohibitions -		air pollution prohibited.
FACILITY	6NYCRR 211.3	
General Prohibitions -		visible emissions limited
A-SSEMB	6NYCRR 212.10 (c) (4) (i)	
NOx and VOC RACT required		at major facilities
B-96000	6NYCRR 212.10 (c) (4) (i)	
NOx and VOC RACT required		at major facilities
FACILITY	6NYCRR 212.4 (a)	
General Process Emission		Sources - emissions from new sources and/or modifications
FACILITY	6NYCRR 212.4 (c)	
General Process Emission		Sources - emissions from new processes and/or modifications
FACILITY	6NYCRR 212.6 (a)	
General Process Emission		Sources - opacity of emissions limited
FACILITY	6NYCRR 215	
FACILITY	6NYCRR 225-1.2 (a) (2)	
Sulfur in Fuel		Limitations Post 12/31/87.
FACILITY	6NYCRR 226.2	
B-25900	6NYCRR 228.10	
Handling, storage and		disposal of VOCs
FACILITY	6NYCRR 228.3 (b)	
VOC incinerator- 80%		overall removal efficiency
B-25900	6NYCRR 228.5	
Reports, recordkeeping,		sampling and analysis
B-25900	6NYCRR 228.5 (g)	
continuous monitoring of		air cleaning device
FACILITY	6NYCRR 229.3 (e) (2) (v)	



Volatile organic liquid

storage tanks

Applicability Discussion:

Mandatory Requirements: The following facility-wide regulations are included in all Title V permits:

ECL 19-301.

This section of the Environmental Conservation Law establishes the powers and duties assigned to the Department with regard to administering the air pollution control program for New York State.

6NYCRR Part 200-6

Acceptable ambient air quality - prohibits contravention of ambient air quality standards without mitigating measures

6NYCRR Part 200-7

Anyone owning or operating an air contamination source which is equipped with an emission control device must operate the control consistent with ordinary and necessary practices, standards and procedures, as per manufacturer's specifications and keep it in a satisfactory state of maintenance and repair so that it operates effectively

6NYCRR Part 201-1.4

This regulation specifies the actions and recordkeeping and reporting requirements for any violation of an applicable state enforceable emission standard that results from a necessary scheduled equipment maintenance, start-up, shutdown, malfunction or upset in the event that these are unavoidable.

6NYCRR Part 201-1.7

Requires the recycle and salvage of collected air contaminants where practical

6NYCRR Part 201-1.8

Prohibits the reintroduction of collected air contaminants to the outside air

6NYCRR Part 201-3.2(a)

An owner and/or operator of an exempt emission source or unit may be required to certify that it operates within the specific criteria described in this Subpart. All required records must be maintained on-site for a period of 5 years and made available to department representatives upon request. In addition, department representatives must be granted access to any facility which contains exempt emission sources or units, during normal operating hours, for the purpose of determining compliance with this and any other state and federal air pollution control requirements, regulations, or law.

6NYCRR Part 201-3.3(a)

The owner and/or operator of a trivial emission source or unit may be required to certify that it operates within the specific criteria described in this Subpart. All required records must be maintained on-site for a period of 5 years and made available to department representatives upon request. In addition, department



emission sources or units subject to this Subpart, during normal operating hours, for the purpose of determining compliance with this and any other state and federal air pollution control requirements, regulations, or law.

6NYCRR Part 201-6

This regulation applies to those terms and conditions which are subject to Title V permitting. It establishes the applicability criteria for Title V permits, the information to be included in all Title V permit applications as well as the permit content and terms of permit issuance. This rule also specifies the compliance, monitoring, recordkeeping, reporting, fee, and procedural requirements that need to be met to obtain a Title V permit, modify the permit and demonstrate conformity with applicable requirements as listed in the Title V permit. For permitting purposes, this rule specifies the need to identify and describe all emission units, processes and products in the permit application as well as providing the Department the authority to include this and any other information that it deems necessary to determine the compliance status of the facility.

6NYCRR 201-6.5(a)(4)

This mandatory requirement applies to all Title V facilities. It requires the permittee to provide information that the Department may request in writing, within a reasonable time, in order to determine whether cause exists for modifying, revoking and reissuing, or terminating the permit or to determine compliance with the permit. The request may include copies of records required to be kept by the permit.

6NYCRR 201-6.5(a)(7)

This is a mandatory condition that requires the owner or operator of a facility subject to Title V requirements to pay all applicable fees associated with the emissions from their facility.

6NYCRR 201-6.5(a)(8)

This is a mandatory condition for all facilities subject to Title V requirements. It allows the Department to inspect the facility to determine compliance with this permit, including copying records, sampling and monitoring, as necessary.

6NYCRR Part 201-6.5(c)

This requirement specifies, in general terms, what information must be contained in any required compliance monitoring records and reports. This includes the date, time and place of any sampling, measurements and analyses; who performed the analyses; analytical techniques and methods used as well as any required QA/QC procedures; results of the analyses; the operating conditions at the time of sampling or measurement and the identification of any permit deviations. All such reports must also be certified by the designated responsible official of the facility.

6NYCRR Part 201-6.5(c)(2)

This requirement specifies that all compliance monitoring and recordkeeping is to be conducted according to the terms and conditions of the permit and follow all QA requirements found in applicable regulations. It also requires monitoring records and supporting information to be retained for at least 5 years from the time of sampling, measurement, report or application. Support information is defined as including all calibration and maintenance records and all original strip-chart recordings for continuous monitoring instrumentation, and copies of all reports required by the permit.



6NYCRR Part 201-6.5(c)(3)(ii)

This regulation specifies any reporting requirements incorporated into the permit must include provisions regarding the notification and reporting of permit deviations and incidences of noncompliance stating the probable cause of such deviations, and any corrective actions or preventive measures taken.

6NYCRR 201-6.5(d)(5)

This condition applies to every Title V facility subject to a compliance schedule. It requires that reports, detailing the status of progress on achieving compliance with emission standards, be submitted semiannually.

6NYCRR Part 201-6.5(e)

Sets forth the general requirements for compliance certification content; specifies an annual submittal frequency; and identifies the EPA and appropriate regional office address where the reports are to be sent.

6NYCRR 201-6.5(f)(6)

This condition allows changes to be made at the facility, without modifying the permit, provided the changes do not cause an emission limit contained in this permit to be exceeded. The owner or operator of the facility must notify the Department of the change. It is applicable to all Title V permits which may be subject to an off permit change.

6NYCRR Part 202-1.1

This regulation allows the department the discretion to require an emission test for the purpose of determining compliance. Furthermore, the cost of the test, including the preparation of the report are to be borne by the owner/operator of the source.

6NYCRR Part 202-2.1

Requires that emission statements shall be submitted on or before April 15th each year for emissions of the previous calendar year.

6NYCRR Part 202-2.5

This rule specifies that each facility required to submit an emission statement must retain a copy of the statement and supporting documentation for at least 5 years and must make the information available to department representatives.

6NYCRR Part 211-.2

This regulation prohibits any emissions of air contaminants to the outdoor atmosphere which may be detrimental to human, plant or animal life or to property, or which unreasonably interferes with the comfortable enjoyment of life or property regardless of the existence of any specific air quality standard or emission limit.

6 NYCRR Part 211.3

This condition requires that the opacity (i.e., the degree to which emissions other than water reduce the transmission of light) of the emissions from any air contamination source be less than 20 percent (six minute average) except for one continuous six-minute period per hour of not more than 57 percent.

6 NYCRR Part 215

Prohibits open fires at industrial and commercial sites.



40 CFR Part 68.

This Part lists the regulated substances and their applicability thresholds and sets the requirements for stationary sources concerning the prevention of accidental releases of these substances.

40 CFR Part 82, Subpart F

Subpart F requires the reduction of emissions of class I and class II refrigerants to the lowest achievable level during the service, maintenance, repair, and disposal of appliances in accordance with section 608 of the Clean Air Act Amendments of 1990. This subpart applies to any person servicing, maintaining, or repairing appliances except for motor vehicle air conditioners. It also applies to persons disposing of appliances, including motor vehicle air conditioners, refrigerant reclaimers, appliance owners, and manufacturers of appliances and recycling and recovery equipment. Those individuals, operations, or activities affected by this rule, may be required to comply with specified disposal, recycling, or recovery practices, leak repair practices, recordkeeping and/or technician certification requirements.

Facility Specific Requirements

In addition to Title V, ENDICOTT INTERCONNECT TECHNOLOGIES INC has been determined to be subject to the following regulations:

40CFR 63-0000.4290

The facility must comply with the emission limits in Table 1 to 40 CFR Part 63, Subpart OOOO.

40CFR 63-0000.4292 (b)

The facility owner or operator must meet the operating requirements of 40 CFR Part 63, Subpart OOOO, Table 2.

40CFR 63-0000.4293 (b)

The facility must develop and implement a work practice plan to minimize fugitive HAP emissions from coating operations.

40CFR 63-0000.4311 (a)

The facility must submit semi-annual reports containing the information in items 40 CFR 63.4311(a).

40CFR 63-0000.4311 (c)

The owner must submit reports of startup, shutdown and/or malfunctions.

40CFR 63-0000.4351

40 CFR 63.4351 describes what must be done to initially document compliance.

40CFR 63-0000.4352

40 CFR 63.4352 explains how to demonstrate continuous compliance.

40CFR 63-0000.4360

40 CFR 63.4360 specifies the stack testing requirements.

40CFR 63-0000.4361

40 CFR 63.4361 specifies procedures for capture system monitoring.

40CFR 63-0000.4364



40 CFR 63.4364 describes what QA must be performed for each continuous parameter monitoring system.

6NYCRR 201-6.5 (b) (1)

This condition implements the EPA's Compliance Assurance Monitoring rule.

6NYCRR 201-6.5 (f)

This regulation defines in general terms under what circumstances changes would be allowed without a permit modification provided the permit contains sufficient operational flexibility provisions.

6NYCRR 212.10 (c) (4) (i)

VOC removal efficiency greater than 81% is considered RACT.

6NYCRR 212.4 (a)

This rule requires compliance with the degree of control specified in Tables 2, 3 and 4 for new (after July 1, 1973) process emission sources.

6NYCRR 212.4 (c)

This rule requires existing sources (in operation after July 1, 1973) of solid particulates with environmental rating of B or C which are not subject to Table 5 "Processes for which Permissible Emission Rate is Based on Process Weight, to be limited to an particulate emission rate not to exceed 0.05 grains per dry standard cubic foot.

6NYCRR 212.6 (a)

This rule specifies an opacity limitation of less than 20% for any six consecutive minute period for all process emission sources.

6NYCRR 225-1.2 (a) (2)

This regulation prohibits any person from selling, offering for sale, purchasing or using any fuel which contains sulfur in a quantity exceeding the limitations set forth in Table 1, Table 2, or Table 3 of this section.

6NYCRR 226.2

General requirements for degreasing operations.

6NYCRR 228.10

This citation specifies the procedures and protocols for the handling, storage and disposal of volatile organic compounds.

6NYCRR 228.3 (b)

This citation requires any volatile organic compound (VOC) incinerator, used as control equipment, to be designed and operated to provide a minimum of 80 percent overall removal efficiency. It also allows an owner or operator of a facility which uses a natural gas fired VOC incinerator as a control device, to shut down the VOC incinerator from November 1st through March 31st for the purposes of natural gas conservation, provided the Department has determined that this action will not jeopardize air quality.

6NYCRR 228.5

Recordkeeping requirements for surface coaters.

6NYCRR 228.5 (g)

The facility is required to monitor the temperature of each oxidizer chamber.

6NYCRR 229.3 (e) (2) (v)



This section requires the tank to be equipped with conservation vents for storage of volatile organic liquids.

Compliance Certification

Summary of monitoring activities at ENDICOTT INTERCONNECT TECHNOLOGIES INC:

Location Facility/EU/EP/Process/ES	Cond No.	Type of Monitoring
B-25900/-/2TO	43	record keeping/maintenance procedures
B-25900/-/2TO	44	monitoring of process or control device parameters as surrogate
B-25900/-/2TO	45	record keeping/maintenance procedures
B-25900/-/2TO	46	record keeping/maintenance procedures
B-25900/-/2TO	47	record keeping/maintenance procedures
B-25900/-/2TO	48	intermittent emission testing
B-25900/-/2TO	49	record keeping/maintenance procedures
B-25900/-/2TO	50	intermittent emission testing
B-25900/-/2TO	51	monitoring of process or control device parameters as surrogate
B-25900/-/2TO	52	record keeping/maintenance procedures
FACILITY	23	record keeping/maintenance procedures
B-25900/-/1NC	41	monitoring of process or control device parameters as surrogate
B-25900/-/2NC	42	monitoring of process or control device parameters as surrogate
FACILITY	5	record keeping/maintenance procedures
FACILITY	6	record keeping/maintenance procedures
FACILITY	25	record keeping/maintenance procedures
FACILITY	7	record keeping/maintenance procedures
A-SSEMB	37	intermittent emission testing
B-96000	53	intermittent emission testing
FACILITY	26	record keeping/maintenance procedures
FACILITY	27	record keeping/maintenance procedures
FACILITY	28	record keeping/maintenance procedures
FACILITY	57	record keeping/maintenance procedures
FACILITY	58	record keeping/maintenance procedures
FACILITY	29	monitoring of process or control device parameters as surrogate
FACILITY	30	monitoring of process or control device parameters as surrogate
FACILITY	31	monitoring of process or control device parameters as surrogate
FACILITY	59	monitoring of process or control device parameters as surrogate



**Permit Review Report
Renewal Number: 1**

Permit ID: 7-0346-00032/00209

10/22/2008

FACILITY	32	record keeping/maintenance procedures
B-25900	40	record keeping/maintenance procedures
FACILITY	33	intermittent emission testing
B-25900	38	record keeping/maintenance procedures
B-25900	39	record keeping/maintenance procedures
FACILITY	34	record keeping/maintenance procedures

Basis for Monitoring

EIT is required to monitor several parameters at this facility. For example, EIT must monitor fuel sulfur content (not to exceed 0.3%). EIT is also required to monitor emission control parameters pursuant to an operation and maintenance manual. The parameters to be monitored depend on the type of device and pollutant to be scrubbed. For the thermal oxidizers, EIT is required to monitor oxidizer temperature. For fabric filters, EIT is required to monitor pressure drop. For carbon adsorption, EIT is required to monitor HC outlet concentration. For wet scrubbers, EIT is required to monitor pH or gallons per minute, scrubber flow.